

December 2019

Motor Solutions Guide



SEMICONDUCTOR & STORAGE PRODUCTS

https://toshiba.semicon-storage.com/

Reasons why Toshiba's motor drivers are chosen

The Interplay of Heritage and Practice

System proposals based on 40 years of experience Experience in collaborative development with system manufacturers in Japan and abroad Deployment of power electronics technology cultivated with R&D and SBUs of Toshiba

Development and Growth

Contributions to efficiency improvement and energy saving Increase in the flexibility of system design Reduction in the amount of heat generated by semiconductor devices Increase in motor drive performance Reduction in package size

Serving as the "Heart and Soul" of Motors

Brushed DC Motor Driver (H-Bridge Driver) ICs	6
Stepping Motor Driver ICs	8
Small Low-Voltage BLDC Motor Driver ICs	12
High-Voltage Brushless DC Motor Driver ICs	14
Discrete Semiconductor Devices	
– Photocouplers (IGBT/MOSFET Drivers, Isolation Amplifiers)	18
– Mid- to High-V _{DSS} MOSFETs	20
- Low-V _{DSS} MOSFETs	22
MCUs: Microcontrollers for Camera Control Applications	24
* Support tools (for MCUs, ICs, and Discrete Transistors)	25

Arm and Cortex are registered trademarks of Arm Limited (or its subsidiaries) in the US and/or elsewhere.
All other company names, product names, and service names may be trademarks of their respective companies.

Types of Toshiba's Motor Drivers and Their Applications

Brushed DC Motor Driver (H-Bridge Driver) ICs p.6



Small Low-Voltage BLDC Motor Driver ICs p.12





High-Voltage Brushless DC Motor Driver ICs p.14



Discrete Semiconductor Devices

• Photocouplers (IGBT/MOSFET drivers, isolation amplifiers) p.18



Applications

- Inverters, AC servos
 Uninterruptible power supplies (UPS), high-power standby power supplies (SPS)
- Power conditioners for photovoltaic power generation



- Mid- to high-V_{DSS} MOSFETs p.20
- Mid- to high-voltage SiC SBDs and discrete IGBTs p.21
- Low-V_{DSS} MOSFETs p.22



• MCUs in small packages suitable for high-precision analog-controlled equipment

^{*} See the Automotive Solutions catalog for automotive motor drivers.

Brushed DC Motor Drivers (H-Bridge Drivers)

Fabricated using a leading-edge BiCD process with low power consumption and low output on-resistance, sealing in thermally enhanced small packages, Toshiba's brushed DC motor drivers help improve the efficiency and reduce the size of motor applications. Toshiba provides brushed DC motor drivers with different supply voltage and output current levels and with different numbers of channels. Therefore, you can select motor driver ICs that best suit your target motors.

Applications

- Consumer electronics and industrial equipment
- Factory automation systems, multi-function printers, office equipment, robotic vacuum cleaners, fan motors, vending machines, home appliances, housing equipment, etc.

Technical discussion

• Latest BiCD and CD silicon technologies: The sophisticated high-voltage 0.13 µm silicon technology helps increase the current and reduce the on-resistance of driving transistors, making it possible to drive a motor with high efficiency and reduce the power consumption of the IC. Toshiba's product portfolio includes brushed DC motor drivers fabricated using a 0.13-µm high-voltage silicon technology.

Incorporating a standby power consumption reduction circuit: TB67H450FNG
The TB67H450FNG, a high-voltage motor driver, provides a maximum standby current of only 1 μA, making it possible to reduce
system standby power consumption. The TB67H450FNG is particularly suitable for reducing the standby discharge current of
battery-powered devices.

HSOP8

50 V 3.5 A Brushed DC Motor Driver (TB67H450FNG)

- Typical pinout
- Wide supply voltage range: 4.5 to 44 V
- Low output on-resistance: 0.6 Ω typical (high side + low side)
- \bullet Low standby supply current: 1 μA maximum at VM = 24 V and Ta = 25°C
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO)
- Small package: HSOP8 with E-pad

8 V 2.0/4.0 A Dual Brushed DC Motor Driver (TC78H653FTG)



- \bullet Supply voltage range: 1.8 to 7.5 V (suitable for low supply voltage drive)
- Low output on-resistance: 0.22 Ω typical per channel (high side + low side) * In Large mode: 0.11 Ω typical
- Low standby supply current: 0.22 μ A maximum at VM = 3 V and Ta = 25°C • Protection features: Thermal shutdown (TSD), overcurrent protection
- (ISD), undervoltage lockout (UVLO)
- Small package: QFN16 with E-pad



• Capable of driving up to four brushed DC motors

- Wide supply voltage range: 6.3 to 38 V
- Low output on-resistance: 0.6 Ω typical per channel (high side + low side) * In Dual mode: 0.3 Ω typical
- Protection features: Thermal shutdown (TSD), overcurrent protection
- (ISD), undervoltage lockout (UVLO)
- Small package: QFN48 with E-pad



Regulato

ISD, TSD, Charge pump

(M)

* 回



Brushed DC Motor Drivers

50 V 4.5/9.0 A Dual Brushed DC Motor Driver (TB67H420FTG)

- High-current drive (9 A)
- Advanced Current Detection System (ACDS)
- Wide supply voltage range: 10 to 47 V
- Low output on-resistance: 0.33 Ω typical per channel (high side + low side) * In Large mode: 0.165 Ω typical
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO)
- Small package: QFN48 with E-pad



50 V 3.0/6.0 A Dual Brushed DC Motor Driver (TB67H401FTG)

- Current limiter and flag (for motor lock detection)
- Wide supply voltage range: 10 to 47 V
- Low output on-resistance: 0.25 Ω typical (high side + low side)
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO)
- Small package: QFN48 with E-pad





• Major Brushed DC Motor Driver products

		Absolute M	Maximum Ratings				ply		Protecti	on		
Part Number	Large Mode	Voltage [V]	Current [A]	Output Ron [Ω]	Circuits (Ch)	C.C. PWM	Single Power Supply	UVLO (1)	ISD (2)	TSD (3)	Temp. Range T_A	Package
TB67H301FTG		40	3.0	1.00	1	٠		•	0/\$	0/\$	-40 to +85°C	QFN24
TB67H302HG		50	5.0	0.40	2	•	٠	•	0	0	-30 to +85°C	HZIP25
TB67H303HG		50	10	0.20	1	٠	٠	•	0	0	-30 to +85°C	HZIP25
TB67H400AFTG/AFNG/AHG/ANG		50	4.0 / 8.0(4)	0.49 / 0.25(4)	2/1(4)	٠	٠	٠	0	0	-20 to +85°C	QFN48/HTSSOP48/HZIP25/SDIP24
TB67H401FTG *		50	3.0 / 6.0(4)	0.49 / 0.25(4)	2/1(4)	٠	٠	٠	0	0	-20 to +85°C	QFN48
TB67H410FTG/NG	•	50	2.5 / 5.0(4)	0.80 / 0.40(4)	2/1(4)	٠	٠	•	0	0	-20 to +85°C	QFN48/SDIP24
TB67H420FTG	•	50	4.5 / 9.0(4)	0.33 / 0.17(4)	2/1(4)	٠	٠	•	0	0	-20 to +85°C	QFN48
TB67H450FNG *		50	3.5	0.6	1	•	٠	•	0	\diamond	-40 to +85°C	SOP8
TB67H452FTG	•	40	3.5 / 5.0(4)	0.60 / 0.30 (4)	4 / 2(4)	٠	٠	•	0	0	-20 to +85°C	QFN48
TC78H600FTG/FNG		18	1.0	1.20	2	٠		•	0	\diamond	-20 to +85°C	QFN24/SSOP20
TC78H611FNG		18	1.1	0.80	2				0	\diamond	-30 to +85°C	TSSOP16
TC78H621FNG		18	1.1	0.80	2			•	0	\diamond	-30 to +85°C	TSSOP16
TC78H630FNG		18	2.1	0.40	1			•	0	\diamond	-30 to +85°C	TSSOP16
TC78H651AFNG *		8	2.0	0.22	2		٠	•	0	\diamond	-40 to +105°C	TSSOP16
TC78H653FTG *	•	8	2.0 / 4.0(4)	0.22 / 0.11(4)	2/1(4)		٠	•	0	\diamond	-40 to +105°C	QFN16
TC78S121FTG/FNG		40	3.5 / 5.0(4)	0.60 / 0.30 (4)	4 / 2(4)	٠	٠	٠	0	0	-20 to +85°C	QFN48/HTSSOP48
TC78S122FTG/FNG		40	3.5 / 5.0(4)	0.60 / 0.30 (4)	4 / 2(4)	٠	٠	٠	0	0	-20 to +85°C	QFN48/HTSSOP48

* : New product

Note (1): Under voltage Lockout (2): Overcurrent detection (3): Thermal shutdown



(3): Thermal shutdown (4): Large Mode

Latch type
 Non latch type

Stepping Motor Drivers

Fabricated using a leading-edge BiCD process with low power consumption and low output on-resistance, Toshiba's stepping motor drivers in thermally enhanced small packages help improve the efficiency and reduce the size of motor applications. These stepping motor drivers incorporate a high-speed, high-precision control technology required for factory automation systems and office equipment, and help reduce the number of external parts required, simplifying system design. Toshiba provides stepping motor drivers with different supply voltage and output current levels and with different numbers of channels. Therefore, you can select motor driver ICs that best suit your target motors.

<Bipolar Stepping Motor Drivers>

<Unipolar Stepping Motor Drivers>



Applications

Factory automation systems, office equipment, vending machines, sewing machines, security cameras, amusement equipment, automatic teller machines (ATMs), etc.

Technical discussion

• Advanced Dynamic Mixed Decay (ADMD):

Toshiba's original ADMD technology controles decay current more adequately than the conventional mixed-decay mode, making highly efficient motor control possible at high rpm.

• Active Gain Control (AGC):

AGC is Toshiba's unique stepping motor technology to automatically optimize the drive current in real time according to load torque. It helps reduce unnecessary current, drastically cut power consumption and heat generation.

• Advanced Current Detection System (ACDS):

Toshiba's original ACDS technology enables motor drive with highly accurate constant current without requiring external current-sensing resistors, which contribute to reduce part count, to save board area as well.

• Microstepping:

The 128-microstep decoder enables high-precision microstepping control only with a clock pulse input. Stair-stepped approximation of a sine wave helps reduce excessive current, heating, and motor vibration, leading to smooth and quiet motor rotation.

- Error detection
 - Thermal Shutdown
 - Overcurrent detection
 - Power-On Reset
 - Motor load open detection

↑ AGC : Activie Gain Control



Microstepping

Close approximation of a sine wave reduces the power loss of motor applications.

Bipolar Stepping Motor Drivers

50 V 5.0 A PWM Chopper-Type Bipolar Stepping Motor Driver (TB67S128FTG)

- Allows microstepping (1/128th step)
- Low output on-resistance: 0.25 Ω typical (high side + low side)
- Advanced Dynamic Mixed Decay (ADMD)
- Active Gain Control (AGC)
- Advanced Current Detection System (ACDS)
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), VM power-on reset (POR), motor load open detection (OPD)
- Small package: VQFN64 with E-pad





50 V 4.0 A Two-Phase Bipolar Stepping Motor Drivers (TB67S101AFTG/AFNG/ANG, TB67S102AFTG/AFNG, TB67S103AFTG, TB67S109AFTG/AFNG, TB67S105FTG)

- Advanced Dynamic Mixed Decay (ADMD)
- Allows 1/32nd-step operation (TB67S103A, TB67S109A)
- Low output on-resistance: 0.49 Ω typical (high side + low side) * TB67S105: 0.6 Ω typical (high side + low side)
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), VM power-on reset (POR)
- Interfaces: Clock input, serial input, phase input
- packages: QFN48、HTSSOP48、HZIP25、SDIP24







40 V 2.0 A PWM Chopper-Type Dual Stepping Motor Drivers (TC78S121FNG/FTG, TC78S122FNG/FTG)

• Capable of controlling two bipolar stepping motors

- Low output on-resistance: 0.6 Ω typical per channel (high side + low side)
- * In Large mode: 0.3 Ω typical
- Single power supply
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), VM power-on reset (POR)
- Interfaces: Clock input, phase input
- Small packages: HTSSOP48, QFN48

50 V 2.0 A Bipolar Stepping Motor Driver (TB67S261FTG, TB67S265FTG, TB67S269FTG)

- Stepping modes:TB67S265FTG: Full-step, half-step TB67S261FTG: Up to 1/4th step TB67S269FTG: Up to 1/8th step, 1/16th step, 1/32nd step
- Low output on-resistance: 0.8Ω typical (high side + low side)
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD),VM power-on reset (POR)
- Interfaces: Clock input, serial input, phase input
- packages: QFN48 (7 mm x 7 mm)



HTSSOP48





OFN48-0707

50 V 4.5/3.0/2.0 A Single-Channel Bipolar Stepping Motor Drivers (TB67S249FTG/289FTG/279FTG)

- Active Gain Control(AGC)
- Advanced Current Detection System (ACDS)
- Low output on-resistance: S249: 0.33 Ω typ., S279: 0.6 Ω typ., S289: 0.4 Ω typ. (high-side + low-side)
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO),
- motor load open detection (OPD)
- Small package: QFN48





Protection

Interface Absolute Maximum Ratings Stepping Mode

• Major Stepping Motor Driver products for Bipolar Motor Applications

		ntena	Le	ADSOLUTE M	aximum kaungs				stepp	ning ivi	oue						Protection	1	
Part Number	Clock	Phase	Serial	Voltage [V]	Current [A]	Constant Current Cont.	Full	Half	1/4	1/8	1/16	1/32	1/64	1/128	Active Gain Control	UVLO	ISD	TSD	Package
TB62261FTG/FTAG		•		40	1.8 (FTG)/ 1.5 (FTAG)	•	•	•	•							•	•	•	QFN48/QFN36
TB62262FTG/FTAG	•			40	1.8 (FTG)/ 1.5 (FTAG)	•	•	•	•							•	•	•	QFN48/QFN36
TB62269FTG/FTAG *	•			40	1.8	٠		٠		٠	٠	٠				٠	•	٠	QFN48/QFN32
TB6600FG/HG	•			50	4.5 (FG)/ 5.0 (HG)	•	•	•	•	•	•					•	•	•	HQFP64/HZIP25
TB67S101AFTG/AFNG/ANG		•		50	4.0	٠	٠	٠	٠							٠	•	•	QFN48/HTSSOP48/SDIP24
TB67S102AFTG/AFNG	•			50	4.0	٠		٠								•	•	•	QFN48/HTSSOP48
TB67S103AFTG	•		٠	50	4.0	٠	٠	٠	•	٠	٠	٠				٠	•	•	QFN48
TB67S105FTG			٠	50	3.0	٠		٠								•	•	٠	QFN48
TB67S109AFTG/AFNG	•			50	4.0	٠		٠	٠	٠	٠	٠				٠	•	٠	QFN48/HTSSOP48
TB67S213FTAG		•		40	2.5	٠	•	٠	٠							•	•	•	QFN36
TB67S215FTAG	•			40	2.5	٠	•	٠	٠							•	•	•	QFN36
TC78S600FTG/FNG	•			18	1.0	٠		•	•	•	•					•	•	•	QFN24/SSOP20
TB6613FTG	•		٠	6	0.8	•		٠					٠			•		•	QON44
TB67S261FTG		•		50	2.0	•	•	٠	•							•	•	•	QFN48
TB67S265FTG			٠	50	2.0	•	•	•								•	•	•	QFN48
TB67S269FTG	•			50	2.0	•	•	٠	٠	•	٠	٠				•	•	•	QFN48
TC78S121FTG/FNG *		•		40	2.0 x 2 ch	•	•	٠	•							•	•	•	QFN48/HTSSOP48
TC78S122FTG/FNG *	•			40	2.0 x 2 ch	•	•	٠	•							•	•	•	QFN48/HTSSOP48
TB67S209FTG *	•			50	4.0	•	•	٠	•	•	•	•				•	•	•	QFN48
TB67S289FTG *	•			50	3.0	•	•	٠	٠	•	٠	•			٠	•	•	•	QFN48
TB67S508FTG *	•	•		40	3.0	٠	•	٠	٠							•	•	•	QFN36
TB67S511FTAG *		•		40	2.0	•	•	٠	٠							•	•	•	QFN36
TB67S512FTAG *	•			40	2.0	•	•	٠	•							•	•	•	QFN36
TB67S521FTAG *		•		40	2.8	•	•	٠	٠							•	•	•	QFN36
TB67S522FTAG *	•			40	2.8	٠	•	٠	•							•	•	•	QFN36
TB67S249FTG *	•			50	4.5	•	•	٠	٠	٠	•	٠			٠	•	•	•	QFN48
TB67S279FTG *	•			50	2.0	•	•	٠	•	•	•	•			•	•	•	•	QFN48
TB67S128FTG *	•			50	5.0	٠	•	٠	٠	•	٠	٠	٠	٠	٠	•	•	•	QFN64
TC78H670FTG **	•			20	2.0	•	•	•	•	•	•	•	٠	•		•	•	•	QFN16

: New Product
 : Under development
 * Only major motor drivers are listed above. For the complete list, visit our website.



Unipolar Stepping Motor Driver

84 V 3.0 A Unipolar Stepping Motor Drivers (TB67S141FTG/HG/NG, TB67S142FTG/HG/NG, TB67S145FTG, TB67S149FTG/FG/HG)

- Constant-current drive and Advanced Current Detection System (ACDS)
- Full-, half-, 1/4th-, 1/8th-, 1/16th-, and 1/32nd-step commutation
- Low output on-resistance: 0.25 Ω typical
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO)
- Interfaces: Phase input, clock input, serial input
- Package: QFN48, HZIP25, SDIP24

80 V 1.5 A Unipolar Stepping Motor Driver (TB67S158FTG/NG)

- Constant-voltage drive
- Capable of controlling two unipolar stepping motors
- Stepping modes: Full-step, half-step
- Low output on-resistance: 0.5 Ω typical
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO)
- Interfaces: Phase input, clock input, serial input, full parallel input
- Package: QFN48, SDIP24

80 V 1.5 A Unipolar Stepping Motor Driver (TB67S111PG)

- Constant-voltage drive
- Stepping modes: Full-step, half-step
- Low output on-resistance: 0.35 Ω typical
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO)
- Interfaces: full parallel input
- Package: DIP16

Major Stepping Motor Driver products for Unipolar Motor Applications



50 V 1.5 A DMOS Transistor Arrays (TBD62064A/TBD62308A)

- Clamp diodes
- Package: DIP16, HSOP16, SSOP24
- Pin-compatible with the previous equivalents (TD62064A/308A)



Part Number	出力形式	# Outputs	Output Current [A]	Output Voltage [V]	Output On-Resistance [Ω]	Clamp Diode	Active Input Level	Package
TBD62064APG/AFG/AFAG	Sink		1.5	50	0.45	•	Н	DIP16/HSOP16/SSOP24
TBD62308APG/AFG/AFAG	SILIK	4	1.5	50	0.38	•	L	DIP16/HSOP16/SSOP24

DIP16















DIP16



ng N	lode				I	Protection	ı
1/8	1/16	1/32	1/64	1/128	UVLO	ISD	TS

-

SSOP24

Small Low-Voltage BLDC Motor Driver ICs

Toshiba provides motor driver ICs suitable for small BLDC motor applications. Housed in a small package, Toshiba's high-efficiency BLDC motor driver ICs incorporate a unique control technology that automatically minimizes the current-voltage phase difference of a motor, reducing its acoustic noise and power consumption.

Applications

• PC and server fans, small fans



Technical discussion – Reducing power consumption and acoustic noise

• Intelligent Phase Control

Intelligent Phase Control (InPAC) is the state-of-the-art motor control technology developed by Toshiba. InPAC minimizes the current-voltage phase difference of a motor over the entire rpm range to improve its power efficiency. Because phase control is automated, InPAC provides an efficiency improvement regardless of the rpm, load torque, and supply voltage of the motor and therefore helps reduce the development workload required for setup and phase adjustment. (See the boxed explanation on Page 16.)

• Closed-loop speed control

Toshiba provides BLDC motor driver ICs that incorporate a closed-loop speed control circuit, which maintains a constant motor speed by reducing variations in rpm due to supply voltage and load variations.

• Sensorless and sine-wave drive technologies

Toshiba provides an extensive lineup of BLDC motor driver ICs that incorporate sensorless and sine-wave drive technologies, which make it possible to reduce the number of parts required for and therefore the size of motor applications, improve their power efficiency, and reduce a motor's acoustic noise. You can select BLDC motor drivers that best suit your application needs.

18 V 3.5 A Three-Phase BLDC Motor Driver (TC78B025FTG)

• Intelligent Phase Control

- Closed-loop speed control
- Operating supply voltage range: 4.5 to 16 V
- Single-sensor-based sine-wave and 150-degree commutation
- Low output on-resistance: 0.2Ω typical (high side + low side)
- RPM control input: PWM or analog voltage input
- Support for Hall effect sensor elements and Hall ICs
- Motor lock protection and automatic recovery functions
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), overcurrent limit protection (OCP), undervoltage lockout (UVLO)





• Small package: VQNF24

18 V Three-Phase BLDC Motor Predriver (TC78B027FTG)

Intelligent Phase Control

- Closed-loop speed control
- \bullet Operating supply voltage range: 5.0 to 16 V
- \bullet Single-sensor-based sine-wave and 150-degree commutation
- Drives external N-channel + N-channel half-bridges
- RPM control input: PWM or analog voltage input
- Support for Hall effect sensor elements and Hall ICs
- Motor lock protection and automatic recovery functions
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), overcurrent limit protection (OCP), undervoltage lockout (UVLO)
- Small package: QNF24



See Page 22 for external MOSFETs.

OFN24-0404

Small Low-Voltage BLDC Motor Drivers

₁₽ ¦

М

18 V 1.5 A Single-Phase Full-Wave Driver (TC78B002FTG/FNG)

- Operating supply voltage range: 3.5 to 16 V
- Soft switching (capable of sine-wave commutation)
- Integrated boot sequence
- Motor lock protection and automatic recovery functions
- Quick start function
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO)
- On-chip voltage regulator: 5 V typical, 10 mA maximum
- Small packages: QNF16, SSOP16

40 V Single-Phase Full-Wave Predriver (TC78B006シリーズ)

- Operating supply voltage range: 3.5 to 30 V
- Soft switching (capable of sine-wave commutation)
- Drives a pair of external P-channel and N-channel half-bridges
- Motor lock protection and automatic recovery functions
- Quick start function
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO)
- On-chip voltage regulator: 5 V typical, 10 mA maximum
- Small packages: QFN16, SSOP16

40 V 3.0 A Three-Phase BLDC Motor Driver (TC78B016FTG)

Intelligent Phase Control

- Operating supply voltage range: 6 to 30 V
- Three-sensor-based sine-wave commutation
- Low output on-resistance: 0.24 Ω typical (high side + low side)
- RPM control input: PWM or analog voltage input
- Support for Hall effect sensor elements and Hall ICs
- Motor lock detection
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), overcurrent limit protection (OCP), undervoltage lockout (UVLO)
- Small packages: QFN36

Major Low-Voltage small BLDC Motor Driver products



QFN36-0505

: New product ** : Under development







SSOP16

OFN16-0303



SAUCHAN

QFN16-0303

SHANAAN

SSOP16

Hall +5V

OSC

*ISD, *TSD 'Lock Pre

High-Voltage BLDC Motor Driver ICs

To reduce a motor's power consumption and acoustic noise, BLDC motors are increasingly used for home appliances. Toshiba provides monolithic ICs incorporating IGBTs fabricated with the latest silicon-on-insulator (SOI) process and multi-chip modules combining well-proven MOSFETs and a driver IC. These BLDC motor driver ICs are available with a rated supply voltage ranging from 250 to 600 V and a rated output current ranging from 0.7 to 5 A, making them suitable for high-efficiency motor applications with an input voltage of 100 to 220 V-AC. Housed in a small package, they also help reduce the board area.







Μ

<Output current of up to 5 A: Sine-wave commutation>





Home appliances

- Air conditioner fans, refrigerator fans, refrigerator compressors, washing machine fans, air purifiers, ceiling fans, etc.

600 V 2.0 A High-Voltage Three-Phase BLDC Motor Driver (TB67B000AHG/AFG)

- SiP (PWM controller and 600-V IPD combination)
- Three-sensor-based sine-wave PWM and trapezoidal commutation
- Support for Hall effect sensor elements and Hall ICs
- External lead angle control
- On-chip oscillator (external resistor required)
- Motor lock detection
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO)
- Package: HDIP30/HSSOP34



Major High-Voltage BLDC Motor Driver products Incorporating a Controller (for Sine-Wave Commutation)

HDIP30

	Absolute Max	imum Ratings	Commutatio	on Waveform	Position	Sensing		Lead Ang	le Control		
Part Number	Voltage [V]	Current [A]	Square	Sine	Sensor-less	Hall Sensor Inputs (# Sensors)	External Input	Auto (current FB)	Auto (rpm FB)	Auto (InPAC)	Package
TB67B000HG/FG	500	2	•	•		3	•				HDIP30/HSSOP34
TB67B000AHG/AFG	600	2	•	•		3	•				HDIP30/HSSOP34

Three-Phase BLDC Motor Driver Incorporating Power Devices (for Square-Wave Commutation)

Capable of phase switching via Hall effect sensor or Hall IC inputs and variable motor speed control via a speed control input

- High-voltage IC fabricated with an SOI process
- Available with a rated voltage ranging from 250 to 600 V and a rated current ranging from 0.7 to 1.0 A
- Incorporates a bootstrap circuit, for high-side gate-drivers
- Protection features: Thermal shutdown (TSD), overcurrent protection (ISD), undervoltage lockout (UVLO)
- Package
- •HSSOP31





Three-Phase BLDC Motor Driver Incorporating Power Devices (for Sine-Wave Commutation)

Capable of sine-wave commutation when combined with a controller (listed on the next page)

- High-voltage IC fabricated with an SOI process
- Available with a rated voltage ranging from 500 to 600 V and a rated current ranging from 2.0 to 5.0 A
- Incorporates a bootstrap circuit, for a high-side gete-drivers
- Protection features: Thermal shutdown (TSD),
- overcurrent protection (ISD), undervoltage lockout (UVLO) Package
- •HSSOP31, SSOP30, HDIP30







• Major High-Voltage BLDC Motor Driver products (for Square-Wave and Sine-Wave Commutation)

			Three-Phase	Commutatio	on Waveform	Position	Sensing		
Part Number	Absolute Maximum Ratings	Package	Distribution PWM Circuit	Square	Sine	Sensor-less	Hall Sensor Inputs (# Sensors)	Output Stage	Structure
TPD4151F	250V / 1A	HSSOP31	•	•	-	-	3	IGBT	Monolithic IC
TPD4162F	600V / 0.7A	HSSOP31	•	•	-	-	3	IGBT	Monolithic IC
TPD4166F	600V/1A	HSSOP31	•	•	-	-	3	IGBT	Monolithic IC
TPD4204F	600V / 2.5A	SSOP30	-					MOSFET	Multi-chip module
TPD4206F	500V / 2.5A	SSOP30	-					MOSFET	Multi-chip module
TPD4207F	600V / 5A	SSOP30	-	(*	1)	(*	1)	MOSFET	Multi-chip module
TPD4164F **	600V / 2A	HSSOP31	-					IGBT	Monolithic IC
TPD4164K **	600V / 2A	HDIP30	-					IGBT	Monolithic IC

** : Under development

(*1) Depends on the preceding controller

Controller Logic

Sine-Wave PWM Three-Phase BLDC Motor Controllers (TC78B041FNG/TC78B042FTG)

• Intelligent Phase Control

- Operating supply voltage range: 6 to 16.5 V
- Three-sensor-based sine-wave commutation
- Support for Hall effect sensor elements and Hall ICs
- Forward and reverse rotation
- Motor lock detection
- Selectable output pulse count per rotation
- On-chip voltage regulator: 5 V typical, 35 mA maximum
- Output current limiting
- Small packages: SSOP30, VQFN32





• Major High-Voltage BLDC Motor Driver and Controller products

	Absolute Max	imum Ratings	Commutatio	on Waveform	Position Se	ensing		Lead Ang	le Control			
Part Number	Voltage [V]	Current [A]	Square	Sine	Sensor-less	Number of Hall Sensor Inputs	External Input	Auto (current FB)	Auto (rpm FB)	Auto (InPAC)	Closed Loop	Package
TB6551FAG	12	0.002		•		3	•					SSOP24
TB6556FG	12	0.002		•		3	•	•				SSOP30
TB6584FNG/AFNG	18	0.002		•		3	•	•				SSOP30
TB6586FG/AFG/BFG	18	0.002	•			3	•					SSOP24
TB6631FNG	18	0.002		•		3	•		•			SSOP30
TB6634FNG	18	0.002		•		3	•	•				SSOP30
TB67B054FTG	18	0.002		•		3	•	•				QFN32
TC78B041FNG *	18	0.002		•		3	•			•		SSOP30
TC78B042FTG *	18	0.002		•		3	•			•		QFN32

* : New Product

Intelligent Phase Control for automatic lead angle control

- Toshiba's unique motor drive technology provides high-efficiency and quiet motor operation.
- Automatic lead angle control eliminates the need for complicated adjustment.

To drive a BLDC motor efficiently, it is necessary to control the phase of the motor drive voltage so that the phase of the motor's induced voltage matches that of the motor current. This is called lead angle adjustment. Since the lead angle varies with a motor's rpm and load torque, lead angle adjustment is a complicated task. Unless the lead angle is properly adjusted, the polarities of the motor voltage and current reverse at zero-crossing points, producing braking torque. This causes acoustic noise and vibration and reduces motor efficiency. Although vector control is employed for high-capacity motors, it has not been widely applied to small motors because of the need for intensive computing and parameter tuning.

Intelligent Phase Control (InPAC) is a technique for automatic lead angle control to achieve high-efficiency motor drive with a simple circuit. InPAC monitors only the polarities of a motor's current and induced voltage, and accordingly adjusts the phase of the motor drive voltage so that they change simultaneously. Because this process is automated, InPAC eliminates the need for complicated lead angle adjustment and requires no external parts. InPAC is effective regardless of a motor's rpm, load torque, and supply voltage and enables a high-efficiency motor operation. Toshiba provides an extensive portfolio of BLDC motor drivers incorporating InPAC. InPAC is Toshiba's unique motor drive technology.



Microcontrollers with Vector Engine (VE)

Toshiba's original coprocessor offloads the CPU considerably.

- Various motor control functions: On-chip peripherals suitable for controlling high-performance BLDC motors, including Vector Engines (VEs), programmable motor drivers (PMDs), encoders (ENCs), AD converters (ADCs), and allows 5 V single-supply operation
- Reliable basic performance: Arm® Cortex®-M3 and Cortex®-M4 cores with a maximum clock rate of 120 MHz
- Extensive lineup: MCUs with 32 to 100 pins, 64 to 512 KB memory options, extensive package lineup
- Extended maximum operating temperature range: -40 to +105°C
- Efficient evaluation environment: Extensive debugging functions and evaluation boards

Applications

• Air conditioner compressors and fans, refrigerator fans, washing machine fans, ceiling fans, and other home appliance motors

Technical discussion – Microcontrollers for motor applications –

• Vector engine (VE)

Vector control is a technique for efficiently turning a BLDC motor over low- to high-rpm regions. To simplify mathematical computations, vector control converts the three-phase AC components (i.e., coil currents) into two-phase orthogonal components, which define the magnetic flux and torque of a motor respectively. This conversion involves three-phase to orthogonal transformation, coordinate system rotation, reverse transformation, and other computations. The Vector Engine performs these mathematical computations in dedicated hardware, considerably offloading the CPU and simplifying software design. Additionally, Toshiba's vector control MCUs contain programmable motor drivers (PMDs), high-speed AD converter interfaces and other peripheral hardware units necessary for motor control in order to perform a sequence of motor control tasks efficiently.





MCUs with Vector Engine (VE) for Inverter Home Appliance Applications (TMPM475xxxx)

- Arm Cortex-M4 with FPU
- Operating frequency: 120 MHz, operating voltage: 4.5 to 5.5 V
- 256 to 512 KB code flash memory
- •100-pin
- Capable of controlling up to two motors simultaneously
- CAN (1 ch)
- Hardware peripherals for motor control (A-VE, PMD, A-ENC, ADC)



Major MCU products with Vector Engine (VE)

Part Number	Maximum Operating Frequency (MHz)	ROM (Flash) (Kbyte)	Motor Controllers (ch)	12-Bit AD Converter (ch) (Conversion time)	Encoder Input Circuits (ch)	CAN (ch)	I/O Port (ch)	Package
TMPM370FYDFG/FYFG	80	256	2	22 (2µS)	2		76	QFP100/LQFP100
TMPM372FWUG	80	128	1	11 (2µS)	1		53	LQFP64
TMPM373FWDUG	80	128	1	7 (2µS)	1		37	LQFP48
TMPM374FWUG	80	128	1	6 (2µS)	2		33	LQFP44
TMPM376FDDFG/FDFG	80	512	2	22 (2µS)	2		82	QFP100/LQFP100
TMPM375FSDMG	40	64	1	4 (2µS)	1		21	SSOP30
TMPM37AFSQG	40	64	1	5 (2µS)			13	VQFN32
TMPM470FYFG/FZFG/FDFG	120	256/384/512	2	23 (1µS)	2		79	LQFP100
TMPM475FYFG/FZFG/FDFG	120	256/384/512	2	23 (1µS)	2	1	79	LQFP100

Photocouplers

Toshiba's extensive portfolio of high-performance IC-output and other types of photocouplers provides total solutions for inverter systems. Toshiba provides smart IGBT gate drivers with protection features fabricated using the latest 0.13-µm BiCD process and high-luminance optically isolated isolation amplifiers.

IGBT/MOSFET-Drive Photocoupler with Overcurrent Protection (TLP5214A)

The TLP5214A is an isolated IGBT/MOSFET gate driver. It provides a protection feature called DESAT, which monitors the saturation voltage, VcE(sat), of an IGBT and performs a soft shutdown of its output when VcE(sat) exceeds 6.5 V typical in the event of an overcurrent condition. Additionally, the TLP5214A is housed in the thin SO16L package and provides active Miller clamping, rail-to-rail output, and other features, reducing the number of external components. This helps reduce bill-of-material (BOM) costs and board size. The TLP5214A provides a clearance distance of 8 mm and guarantees an isolation voltage of up to 5 kVrms, making it suitable for applications requiring high insulation performance.

- Vce(sat) detection and shutdown protect an IGBT/MOSFET in the event of overcurrent.
- The FAULT signal is fed back to the controller at high speed.
- Active Miller clamping prevents IGBT/MOSFET failures due to Miller current.
- A rail-to-rail output reduces power loss.
- Maximum output peak current: 4.0 A
- Propagation delay (tphL / tpLH): 150 ns max





Soft Shutdown Waveform Example



Conditions: $\label{eq:generalized_states} \begin{array}{l} \mbox{Conditions:} \\ \mbox{F}=10mA, Vcc=30V, Rg=10\Omega, Cg=25nF, Ta=25\ C \\ \mbox{F}: 10mA/div, Vo: 10V/div, Vdesat: 2V/div, 1\mus/div \\ \end{array}$

High-Precision Isolation Amplifier with a High-Performance $\Delta\Sigma$ AD Converter (TLP7820)

Typical AC servo inverters for industrial applications require feedback of the motor current. Therefore, the signal lines of a CPU or an MPU that control inverter circuitry at low voltage must be isolated from the current lines of a three-phase motor that operated at high voltage. Toshiba's optically isolated isolation amplifier, the TLP7820, provides a solution for this requirement. The TLP7820 has an analog-output delta-sigma AD converter.

- Exhibits primary-side current consumption of only 9 mA typical and thus helps to reduce the size of power supplies
- Unique test mode that makes it possible to monitor internal characteristics
- Housed in the thin SO8L package and thus can be soldered on the backside of a PCB









Recommended Photocouplers for Motor Applications

• IC Output IPM Drive

		in Configuration Toshiba's Features		Propagation		Isolation voltage		Safet	y Standa	rds ⁽¹⁾	
Part Number	Pin Configuration	Package Name	Features	delay time	Output	t=60s (Vrms)	UL 1577 ⁽²⁾	c-UL ⁽³⁾	VDE ⁽⁴⁾	VDE ⁽⁵⁾	CQC ⁽⁶⁾
TLP2719		SO6L SO6L(LF4)	Reinforced insulation VCC = 4.5 to 20 V Topr (max) 100°C Io/IF 15 to 55% (@IF=16 mA)	2 μs (max)	Open-collector (Analog signal output)	5000	0	0	0	0	0
TLP2704		SO6L SO6L(LF4)	Reinforced insulation VCC = 4.5 to 20 V Topr (max) 125°C Threshold Input Current (max) 5 mA	550 ns (max)	Open-collector (Inverter logic output)	5000	0	0	0	0	0
TLP2745		SO6L SO6L(LF4)	Reinforced insulation Topr (max) 110°C Threshold Input Current (max) 1.6 mA	120 ns (max)	Totempole (Buffer logic output)	5000	0	0	0	0	0

• IC Output IGBT/MOSFET Gate Drive

		Toshiba's		Propagation	Peak		Isolation voltage		Safe	ty Standa	rds ⁽¹⁾	
Part Number	Pin Configuration	Package Name	Features	delay time	output current	Input Current (mA)	t=60s (Vrms)	UL 1577 ⁽²⁾	c-UL ⁽³⁾	VDE ⁽⁴⁾	VDE ⁽⁵⁾	CQC ⁽⁶⁾
TLP5214A	E V/V E E V/G V/G E V/G <td>SO16L</td> <td>Smart gate drive photocoupler Direct drive of a mediumpower IGBT/MOSFET Overcurrent protection, Soft shutdown Active miller clamp Rail to Rail output Topr (max) 110°C</td> <td>0.15 μs (max)</td> <td>±4.0 A</td> <td>I_{FLH}=6 (max)</td> <td>5000</td> <td>0</td> <td>0</td> <td>0</td> <td>0</td> <td>-</td>	SO16L	Smart gate drive photocoupler Direct drive of a mediumpower IGBT/MOSFET Overcurrent protection, Soft shutdown Active miller clamp Rail to Rail output Topr (max) 110°C	0.15 μs (max)	±4.0 A	I _{FLH} =6 (max)	5000	0	0	0	0	-
TLP5754 TLP5754 (LF4)		SO6L SO6L (LF4)	Direct drive of a mediumpower IGBT/MOSFET Rail to Rail output Topr (max) 110°C	0.15 μs (max)	±4.0 A	I _{FLH} =4 (max)	5000	0	0	0	0	0
TLP5774 TLP5774 (LF4)		SO6L SO6L (LF4)	Direct drive of a mediumpower IGBT/MOSFET Vcc = 10V (min) Topr (max) 110℃	0.15 μs (max)	±4.0 A	I _{FLH} =2 (max)	5000	0	0	0	0	0

• Isolation Amplifier Analog output

			Toshiba's				de supply curre	nt (loo1)/	Isolation voltage		Safe	ty Standa	rds ⁽¹⁾	
	Part Number	Pin Configuration	Package Name	Features	Specific	ations (mA/m	side supply cur A)	rent (IbbZ)	t=60s (Vrms)	UL 1577 ⁽²⁾	C-UL ⁽³⁾	VDE ⁽⁴⁾	VDE ⁽⁵⁾	CQC ⁽⁶⁾
TIC	7820		CO0L (I E 4)	Analog output Isolation amplifier	Gain accuracy (Ta=25 °C Rank max)	Output nonlinearity	Input offset voltage		5000			0		
TLP	/1820		SO8L (LF4)	Gain = 8.2 (typ.) Topr (max) 105℃	±0.5% ±1% ±3%	0.02%	0.9 mV	12/10	5000	0	0	0	0	0
TLP	27830	ΔΣ ADC	SO8L (LF4)	1 bit Digital & CLK output Isolation amplifier	SNDR Ta=25°C (typ)	SNR Ta=25°C (typ)	INL (LSB) (typ)	12/8.0	5000	0	0	0	0	0
		1 2 3 4		Topr (max) 105℃	75 dB	80 dB	4							

• High Speed Communications

		Toshiba's		Data Rate		@ F(IN)	Isolation voltage		Safe	ty Standa	rds ⁽¹⁾	
Part Number	Pin Configuration	Package Name	Package Name Features		Output	(mA)	t=60sec (Vrms)	UL 1577 ⁽²⁾	c-UL ⁽³⁾	VDE ⁽⁴⁾	VDE ⁽⁵⁾	CQC ⁽⁶⁾
TLP2768A		SO6L SO6L(LF4)	Reinforced insulation Topr (max) 125℃	20M bit/s	Open-collector (Inverter logic output)	IFHL=5 (max)	5000	0	0	0	0	0

• Transistor Output DC Input

		Toshiba's		CTR VCEO Isola				Isolation voltage						
Part Number	Pin Configuration	Package Name	Features	Rank	Min (%)	Max (%)	@IF, Vce (mA, V)	(V)	t=60s (Vrms)	UL 1577 ⁽²⁾	c-UL ⁽³⁾	VDE ⁽⁴⁾	VDE ⁽⁵⁾	CQC ⁽⁶⁾
TLP183		4pin SO6	Reinforced insulation Low input drive current Topr (max) 125°C	- Y YH	50 50 75	600 150 150	0.5, 5	80	3750	0	0	0	0	0
TLP185 (SE		4pin SO6	Reinforced insulation General-purpose	GR	100	300	5, 5	80	3750	0	0	0	0	0
TLP291 (SE		SO4	Reinforced insulation Lead pitch : 1.27 mm	GRL GRH	100 150	300	5, 5	80	3750	0	0	0	0	0
TLP293		SO4	Reinforced insulation Low input drive current Topr (max) 125℃	GB BL BLL	100 200 200	600 600 400	0.5, 5	80	3750	0	0	0	0	0

Note (1): Certified to safety standards. For details on certification status, contact your Toshiba sales representative.

: Certified to safety standards. For details on certification status, contact your Toshiba UL/c-UL/CQC: O: Approved <u>A</u>: Approval pending as of April 2019 VDE: O: Approved <u>A</u>: Approval pending as of April 2019 Specify VDE-certified devices with option V4 or D4 UL: Underwriters Laboratories (UL) is a safety consulting and certification company. c-UL: c-UL Mark is the UL Mark for Canada. VDE: VERBAND DEUTSCHER ELECTROTECHNISCHER e.V. CQC: China Quality Certification center

(2): UL 1577 Standard for Optical Isolators (3): UL 1577 Optical Isolators Certified for Canada (4): EN 60747-5-5 (5): EN 60065, EN 60950-1 or EN 62368-1 (6): GB4943.1, GB8898

High-Voltage MOSFETs (Super-Junction MOSFET)

Fabricated with a single-epitaxial process, Toshiba's super-junction MOSFET DTMOS-IV series provides RonA 30% lower than that of the previous DTMOS-III series and therefore helps reduce system size and power consumption.

Technical discussion – High efficiency and low heat generation because of low Ron and short recovery time –

• The three DTMOSIV series satisfy various requirements for MOSFETs.

• DTMOSIV

Standard series High-speed diode series

DTMOSIV HSD
 DTMOSIV-H

High-speed-switching series

Part number suffix: W Part number suffix: W5 Part number suffix: X e.g. TK31N60W e.g. TK31N60W5 e.g. TK31N60X

• DTMOS IV (HSD) Series

The DTMOSIV HSD series provides a recovery time approximately 70% shorter than the standard DTMOSIV series and thus helps reduce recovery loss due to the parasitic diode. It is the ideal choice for half- and full-bridges for AC-DC power supplies as well as for motor drive applications.

• 30% lower RonA than the previous series

Due to reduced RonA, the DTMOS IV series helps improve power efficiency.

This makes it possible to house more chips in a single package, contributing to reducing the size of motor applications.

Coss loss: Eoss reduction

The reduced Eoss helps improve efficiency at light load.

• The use of a single-epitaxial process helps reduce on-resistance and therefore temperature increase.

The reduction in temperature increase in the high-temperature region contributes to improving efficiency.



Comparisons of Representative Parts

DTMOSIV	Standard Series	HSD Series
Part Number	TK7P60W	TK7P60W5
Package	DPAK	DPAK
Ratings	600V/7A	600V/7A
On-resistance (max)	0.60Ω	0.67Ω
Recovery time (trr)	230ns	75ns

DTMOSIV HSD Series (with 600-V VDss and High-Speed Recovery Diode)

		DPAK (TO-252)	D2PAK (TO-263)	DFN8×8	TO-220	TO-220SIS	TO-3P (N)	TO-247			
lo (A)	Rds (ON) MAX (Ω)								Qg (nC) Typ.	C _{iss} (V _D s=300V) (pF) Typ.	t _{rr} (ns) Typ.
7	0.65 / 0.67	TK7P60W5 (0.67Ω)				TK7A60W5			16	490	75
8	0.54 / 0.56	TK8P60W5 (0.56Ω)				TK8A60W5			22	590	80
9.7	0.45					TK10A60W5			23	720	85
15.8	0.23 / 0.24		TK16G60W5	TK16V60W5 (0.24Ω)	TK16E60W5	TK16A60W5	TK16J60W5	TK16N60W5	43	1350	100
20	0.175/0.19			TK20V60W5 (0.19Ω)	TK20E60W5	TK20A60W5	TK20J60W5	TK20N60W5	55	1800	110
25	0.14 / 0.15			TK25V60X5 (0.15Ω)*1	TK25E60X5*1	TK25A60X5*1		TK25N60X5*1	60	2400	120
30.8	0.099 / 0.109			TK31V60W5 (0.109Ω)			TK31J60W5	TK31N60W5	105	3000	135
38.8	0.074						TK39J60W5	TK39N60W5	135	4100	150
61.8	0.045						TK62J60W5	TK62N60W5	205	7100	170

*1: High speed switching/recovery type, suffixed by "X5"

DTMOSIV HSD Series (with 650-V Voss and High-Speed Recovery Diode)

lo (A)	R _{DS (ON)} MAX (Ω)	DPAK (TO-252)	D2PAK (TO-263)	DFN8×8	TO-220	TO-220SIS	TO-3P (N)	TO-247	Qg (nC) Typ.	C _{iss} (V _{DS} =300V) (pF) Typ.	tır (ns) Typ.
13.7	0.3		TK14G65W5		TK14E65W5	TK14A65W5		TK14N65W5	40	1300	100
17.3	0.23					TK17A65W5			50	1800	110
22	0.16 / 0.17			TK22V65X5 (0.17Ω)		TK22A65X5			50	2400	110
27.6	0.13/0.14			TK28V65W5 (0.14Ω)				TK28N65W5	90	3000	115
35	0.095					TK35A65W5		TK35N65W5	115	4100	130
49.2	0.057							TK49N65W5	185	6500	145

Discrete IGBTs

The current sixth-generation discrete IGBTs are fabricated with small field-stop and gate geometries to reduce power loss. Toshiba will employ a field-stop structure and a new gate structure for the seventh-generation IGBTs to further optimize the trade-off between high-speed switching speed and low power loss.



SiC Schottky Barrier Diodes

1.5A

20A 30A

600V

Toshiba offers an extensive portfolio of small, high-efficiency diodes, including SiC Schottky barrier diodes (SBDs) featuring high-speed operation and low forward loss.

2.0V

30W

45W

230W

TO-220SIS

TO-220SIS

TO-3P (N)

The use of the Junction Barrier Schottky (JBS) structure reduces leakage current compared to the typical SBD structure, making it possible to realize stable operation even at high voltage and high current.

Features of the Second-Generation Products (Compared to the First-Generation Products)

GT15J341

GT20J341

GT30J341

1.5V





Major SiC Schottky Barrier Diode products

Absolute Max	imum Ratings	Pa	rt Number / Packagi	ing	Elec	trical Characte	ristics (Ta=25°C))
VRRM	IF (DC)	TO-220-2L	TO-220-2L TO-247		VF @IF		Cj (pF) @650V,	Irrm (uA)
(V)	(A)		(Isolation)	(Center tap)	Тур.	Max	1MHz	@Vrrm
	2	TRS2E65F			1.45	1.6	8.7	20
	3	TRS3E65F			1.45	1.6	12	20
	4	TRS4E65F	TRS4A65F		1.45	1.6	16	20
	6	TRS6E65F	TRS6A65F		1.45	1.6	22	30
650	8	TRS8E65F	TRS8A65F		1.45	1.6	28	40
000	10	TRS10E65F	TRS10A65F		1.45	1.6	36	50
	12	TRS12E65F	TRS12A65F		1.45	1.6	44	60
	12			TRS12N65FB **	1.45	1.6	22 (1)	30 (1)
	16			TRS16N65FB **	1.45	1.6	28 (1)	40 (1)
	20			TRS20N65FB **	1.45	1.6	36 (1)	50 ⁽¹⁾
	24			TRS24N65FB **	1.45	1.6	44 (1)	60 (1)



TO-247 (center-tapped)

** : Under development

(1) Per leg per device

30% lower switching loss (examples of 650-V and 10-A diodes)

TO-220SIS

TO-3P (N)

Low-Voltage MOSFETs

Toshiba has endeavored to reduce the power losses of MOSFET by optimizing cell structure with fine integration technologies.

Features

- Low on-resistance due to the use of a small-geometry process
- Low power losses due to an improved trade-off between on-resistance and charge characteristics
- MOSFETs with a wide range of Voss and extensive packaging options suitable for various applications
- High avalanche ruggedness and ESD tolerance
- Optimized device structure for ease of application design with switching noise reduced

Conduction and Output Charge Losses

* Comparison with a MOSFET from another manufacturer



Qoss: Output charge (figure of merit for output charge loss)

Technical discussion – Reducing system size and increasing power density –

- DSOP Advance (double-sided-cooling package)
- 1. The DSOP Advance package efficiently dissipates heat from the metal plates on the top and bottom surfaces. The DSOP Advance package provides a higher current capacity than the conventional package of the same size and therefore helps save PCB space and reduce the system size.
- 2. The DSOP Advance package is footprint-compatible with the SOP Advance package. The DSOP Advance package can be replaced by the SOP Advance package without modifying the PCB layout.
- 3. The DSOP Advance package has lower resistance.





U-MOSIX-H/U-MOSVIII-H series Major 30-V, 40-V, and 60-V MOSFET products in the SOP Advance and SOP Advance (N) Packages

		Absolut	e Maximum	Ratings		RDS (ON	ı (mΩ)		Ciss	O _g	r _g (Typ)
Part Number	Series	V _{DSS} (V)	V _{GSS} (V)	lo (A)	Vgs -	10V	V _{GS} =	4.5V	(Typ.)	Qs (Typ.) (nC) 46 81 74 110 74 103 72 60 91	
		VDSS (V)	VGSS (V)	ID (A)	Тур.	Max.	Тур.	Max.	(pF)		(Ω)
TPH1R403NL	U-MOSVIII-H	30	+/-20	150 ^{SL}	1.2	1.4	1.7	2.1	3400	46	1.1
TPHR9203PL	U-MOSIX-H	30	+/-20	280 ^{SL}	0.61	0.92	0.91	1.29	5800	81	0.5
TPHR9003NL	U-MOSVIII-H	30	+/-20	220 ^{SL}	0.77	0.9	1.1	1.4	5300	74	1.2
TPHR6503PL	U-MOSIX-H	30	+/-20	393 ^{sl}	0.41	0.65	0.6	0.89	7700	110	0.6
TPH1R204PL	U-MOSIX-H	40	+/-20	246 ^{SL}	1.0	1.24	1.5	2.1	5500	74	0.6
TPHR8504PL	U-MOSIX-H	40	+/-20	340 ^{sl}	0.7	0.85	1.0	1.4	7370	103	0.6
TPH2R306NH	U-MOSVIII-H	60	+/-20	130 ^{SL}	1.9	2.3	-	-	4700	72	1.1
TPH2R506PL	U-MOSIX-H	60	+/-20	160 ^{SL}	1.9	2.5	2.8	4.4	4180	60	0.6
TPH1R306PL	U-MOSIX-H	60	+/-20	260 ^{SL}	1.0	1.34	1.5	2.3	6250	91	0.5





Major 30-V, 40-V, and 60-V MOSFET products in the DSOP Advance Package

		Absolute Maximum Ratings				RDS (ON) (mΩ)		Ciss	Qg	ŕg
Part Number	Series	VDSS (V)	VGSS (V) ID (A)		V _{GS} =10V		Vgs=4.5V		(Typ.)	(Typ.)	(Typ)
		AD22 (A)	VG55 (V)	ID (A)	Тур.	Max.	Тур.	Max.	(pF)	(nC)	(Ω)
TPWR8503NL	U-MOSVIII-H	30	+/-20	300 ^{SL}	0.72	0.85	1.0	1.3	5300	74	1.2
TPWR6003PL	U-MOSIX-H	30	+/-20	412 ^{SL}	0.36	0.6	0.6	0.84	7700	110	0.6
TPWR8004PL	U-MOSIX-H	40	+/-20	340 ^{SL}	0.65	0.8	0.95	1.4	7370	103	0.6
TPW1R005PL	U-MOSIX-H	45	+/-20	300 ^{SL}	0.75	0.99	1.15	1.65	7700	122	0.6
TPW1R306PL	U-MOSIX-H	60	+/-20	260 ^{SL}	0.95	1.29	1.5	2.3	6250	91	0.5



Low-Voltage MOSFET Applications (Power Tools)

Low-voltage MOSFET is applied to wider voltage range because of the variety of battery voltage such as 12 and 48V. Toshiba provides wide variety of voltage and package lineup.

<Requirement for MOSFETs for main switch applications> Low on-resistance Low on-resistance Lower switching loss Good reverse recovery performance



Electric Speed Controller (ESC) Module for Industrial Drone Applications (TPMD0001A)

The TPMD0001A is an ESC module containing the **TMPM475FYFG** vector control MCU and the **TPH1R204PL** MOSFETs with low heat dissipation in a small package. It handles two-way communication via Control Area Network (CAN). Two-way CAN communication allows the ESC to transmit information about voltage, current, temperature, etc. to the main controller, greatly improving a drone's safety performance, i.e., the ability not to crash or become uncontrollable.

The use of vector control helps reduce the power consumption, vibration, and acoustic noise of a motor as well as its rpm variations due to load variations. The TPMD0001A helps reduce the size and weight of 24-V/50-A-class ESCs.



Microcontrollers for Camera and Other Small Applications

Toshiba provides MCUs in small packages incorporating a high-resolution programmable pulse generator (PPG) suitable for high-precision analog-controlled equipment. These MCUs allow parallel processing, making it possible to reduce the operating frequency.

Features

- Up to four programmable servo/sequence controller (PSC) units (suitable for servo computation, motor control, and communication sequencing for camera shake compensation)
- High-resolution PPG for ultrasound control
- Various timer serial interfaces

Applications

• Security cameras, camera lenses, digital video cameras



MCUs with a Programmable Servo/Sequence Controller (PSC) suitable for high-precision motor control applications (TMPM343FDXBG/10XBG)

The TMPM343FDXBG and TMPM310XBG incorporate a programmable serve/sequence controller (PSC) required for camera shake compensation, auto-focus tracking for video, lens control and overall system control, as well as motor controller/drivers and analog circuitry. The high-performance ARM Cortex-M3 core provides high-speed computation.

Additionally, a micro-step driver and a high-resolution programmable phase generator (PPG) enable smooth and quiet motor operation.



Package: VFBGA162 (7 x 7 mm, 0.5 mm pich)

System Block Diagram (Camera Lens)



* The TMPM343 contains four PSC units. The TMPM342 contains one PSC unit.

BOD)

• Microcontrollers for Camera and Other Small Applications

Part Number	Maximum Operating Frequency (MHz)	ROM(Flash) (K Bytes)	SRAM (K Bytes)	PSC (ch)	PPG (ch)	PHC (ch)	I/O Port (ch)	Package
TMPM342FYXBG	40	256	36	1	8	2	63	VFBGA142
TMPM343FDXBG	- 50	512	80	4	10	2	50	VFBGA162
TMPM343F10XBG		1024	96	4	16	3	59	VEDGA162
TMPM440FEXBG	100	768	80	1	4	PHC: 2	228	VFBGA289
TMPM440F10XBG	100	1024	00	1 I	4	EPH: 1	228	VEDGA289

MCU Development Support Tools

Various development tools are available for Arm-core-based MCUs. Visit Toshiba's website to choose the best development tools and partners that suit your needs.

Development Environment

Genuine MDK-Arm development environment



■IAR Systems' EWARM development environment



Sample Programs

Our website provides sample programs that customers can use as references to evaluate the functionality of our microcontrollers and develop applications.

Sample programs for motor control are available among those for the M370 Group of the TX03 Series.

	Sample Program/Euroction			Product Name								
Sample Program/Fu	nction	Description	TMPM 370	TMPM 372	TMPM 373	TMPM 374	TMPM 375	TMPM 376	TMPM 37A			
Motor Control Circuit	PMD	This example demonstrates the phase outputs.	v	v	v	v	v	v	v			

https://toshiba.semicon-storage.com/ap-en/design-support/referencedesign.html

Evaluation Kits

In order to evaluate whether to use Toshiba's microcontroller, it is advisable to use entry-level or other evaluation kits to start software development. Evaluation kits are available from development environment and evaluation kit vendors.

For details of evaluation kits, visit our website at: https://toshiba.semicon-storage.com/jp/product/microcomputer/designsupport/reference-model.html



ESP-kikaku Co., Ltd

Reference Design Center

• The Reference Design Center is an open environment that provides reference designs for motor control and other applications to help you save the time and effort required for circuit design and consideration.



https://toshiba.semicon-storage.com/ap-en/design-support/referencedesign.html

• In addition to technical documents, the Reference Design Center provides data for electronic design automation (EDA) tools, which can be modified, processed, and partially used to suit your design according to its specifications.

Design Documents



Design Files



Circuit Data (OrCAD®)

Development Support Tools

• More than 100 types of MCD evaluation boards are available for different types of motors.



• You can purchase evaluation boards from one of the following online sites.



https://www.digikey.jp/



omarutsu®

http://sv.marutsu.co.jp/toshiba/



Marutsuelec Co., Ltd.

• Development documents and simulation models (datasheets, reference guides, BOM lists, PCB files, and PSpice models) are available for download from Toshiba's website.



Motor Solutions Guide

RESTRICTIONS ON PRODUCT USE

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- ▶ TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or application; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, lifesaving and/or life supporting medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, and devices related to power plant. IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your TOSHIBA sales representative or contact us via our website.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- Product may include products using GaAs (Gallium Arsenide). GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Product may include products subject to foreign exchange and foreign trade control laws.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

In addition to the above, the following are applicable only to development tools.

- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Use the Product in a way which minimizes risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. For using the Product, customers must also refer to and comply with the latest versions of all relevant TOSHIBA information, including without limitation, this document, the instruction manual, the specifications, the data sheets for Product.
- Product is provided solely for the purpose of performing the functional evaluation of a semiconductor product. Please do not use Product for any other purpose, including without limitation, evaluation in high or low temperature or humidity, and verification of reliability.
- > Do not incorporate Product into your products or system. Products are for your own use and not for sale, lease or other transfer.

TOSHIBA

Toshiba Electronic Devices & Storage Corporation

Website: https://toshiba.semicon-storage.com/

Motor Solutions Guide